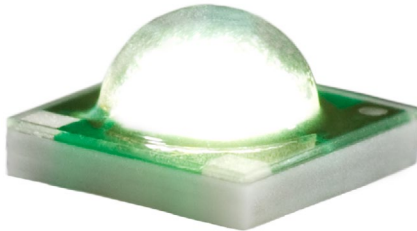


## Cree® XLamp® XP-C LEDs



### PRODUCT DESCRIPTION

The XLamp® XP-C LED combines the proven lighting-class performance and reliability of the XLamp XR-E LED in a package with 80% smaller footprint. The XLamp XP-C LED continues Cree’s history of innovation in LEDs for lighting applications with wide viewing angle, symmetrical package, unlimited floor life and electrically neutral thermal path.

Cree XLamp LEDs bring high performance and quality of light to a wide range of lighting applications, including color-changing lighting, portable and personal lighting, outdoor lighting, indoor directional lighting, commercial lighting and emergency-vehicle lighting.

### FEATURES

- Available in white (2600 K to 10,000 K CCT), royal blue, blue, green, amber, red-orange, red
- Maximum drive current: up to 500 mA
- Low thermal resistance: as low as 10 °C/W
- Wide viewing angle: 110° – 125°
- Unlimited floor life at ≤ 30 °C/85% RH
- Reflow solderable - JEDEC J-STD-020C compatible
- Electrically neutral thermal path
- RoHS- and REACH-compliant
- UL® recognized component (E349212)



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**CHARACTERISTICS**

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point - white, royal blue, blue	°C/W		12	
Thermal resistance, junction to solder point - green	°C/W		20	
Thermal resistance, junction to solder point - amber	°C/W		15	
Thermal resistance, junction to solder point - red, red-orange	°C/W		10	
Viewing angle (FWHM) - white	degrees		115	
Viewing angle (FWHM) - royal blue, blue, green, red, red-orange, amber	degrees		125	
Temperature coefficient of voltage - white, blue, royal blue, green	mV/°C		-4.0	
Temperature coefficient of voltage - amber, red-orange, red	mV/°C		-2.0	
ESD withstand voltage (HBM per Mil-Std-883D) - white, royal blue, blue, green	V			8000
ESD Classification (HBM per Mil-Std-883D) - amber, red-orange, red			Class 2	
DC forward current - white, royal blue, blue, green	mA			500
DC forward current - amber, red-orange, red	mA			350
Reverse voltage	V			5
Forward voltage (@ 350 mA) - white	V		3.2	3.9
Forward voltage (@ 350 mA) - royal blue, blue	V		3.3	3.9
Forward voltage (@ 350 mA) - green	V		3.4	3.9
Forward voltage (@ 350 mA) - amber, red-orange, red	V		2.2	2.5
Forward voltage (@ 125 mA) - royal blue, blue	V		3.1	
Forward voltage (@ 125 mA) - green	V		3.3	
Forward voltage (@ 125 mA) - red-orange, red	V		2.0	
Forward voltage (@ 125 mA) - amber	V		2.1	
Forward voltage (@ 500 mA) - royal blue, blue, white	V		3.5	
Forward voltage (@ 500 mA) - green	V		3.6	
LED junction temperature	°C			150

### FLUX CHARACTERISTICS - WHITE ( $T_j = 25\text{ }^\circ\text{C}$ )

The following table provides several base order codes for XLamp XP-C LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XP LED Family Binning and Labeling document.

Color	CCT Range		Minimum Luminous Flux @ 350 mA		Order Code
	Min.	Max.	Group	Flux (lm)	
Cool White	5000 K	10,000 K	Q2	87.4	XPCWHT-L1-0000-00A01
			Q3	93.9	XPCWHT-L1-0000-00B01
			Q4	100	XPCWHT-L1-0000-00C01
Neutral White	3700 K	5300 K	P3	73.9	XPCWHT-L1-0000-008E4
			P4	80.6	XPCWHT-L1-0000-009E4
			Q2	87.4	XPCWHT-L1-0000-00AE4
Warm White	2600 K	3700 K	N4	62.0	XPCWHT-L1-0000-006E7
			P2	67.2	XPCWHT-L1-0000-007E7
			P3	73.9	XPCWHT-L1-0000-008E7

#### Notes:

- Cree maintains a tolerance of  $\pm 7\%$  on flux and power measurements,  $\pm 0.005$  on chromaticity (CCx, CCy) measurements and  $\pm 2$  on CRI measurements. See the Measurements section (page 14).
- Typical CRI for Cool White (5000 K – 10,000 K CCT) is 70.
- Typical CRI for Neutral White (3700 K – 5300 K CCT) is 75.
- Typical CRI for Warm White (2600 K – 3700 K CCT) is 80.

## FLUX CHARACTERISTICS - COLOR ( $T_j = 25\text{ }^\circ\text{C}$ )

The following tables provide several base order codes for XLamp XP-C LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XP LED Family Binning and Labeling document.

Color	Dominant Wavelength Range				Minimum Radiant Flux @ 350 mA		Calculated Minimum Radiant Flux (mW) @ 125 mA*	Order Code
	Min.		Max.		Group	Flux (mW)		
	Group	DWL (nm)	Group	DWL (nm)				
Royal Blue	D3	450	D5	465	12	250	104	XPCROY-L1-0000-00701
					13	300	124	XPCROY-L1-0000-00801
					14	350	145	XPCROY-L1-0000-00901

Color	Dominant Wavelength Range				Minimum Luminous Flux 350 mA		Calculated Minimum Luminous Flux (lm) @ 125 mA*	Order Code
	Min.		Max.		Group	Flux (lm)		
	Group	DWL (nm)	Group	DWL (nm)				
Blue	B3	465	B6	485	J	23.5	10.8	XPCBLU-L1-0000-00W01
					K2	30.6	13.8	XPCBLU-L1-0000-00Y01
					K3	35.2	15.9	XPCBLU-L1-0000-00Z01

Color	Dominant Wavelength Range				Minimum Luminous Flux 350 mA		Calculated Minimum Luminous Flux (lm) @ 125 mA*	Order Code
	Min.		Max.		Group	Flux (lm)		
	Group	DWL (nm)	Group	DWL (nm)				
Green	G2	520	G4	535	N3	56.8	28.2	XPCGRN-L1-0000-00501
					N4	62	30.8	XPCGRN-L1-0000-00601
					P2	67.2	33.3	XPCGRN-L1-0000-00701
					P3	73.9	36.7	XPCGRN-L1-0000-00801
					P4	80.6	40.0	XPCGRN-L1-0000-00901

\* Calculated values for reference only

Note: Cree maintains a tolerance of  $\pm 7\%$  on flux and power measurements and  $\pm 1\text{ nm}$  on dominant wavelength measurements. See the Measurements section (page 14).

**FLUX CHARACTERISTICS - COLOR (T<sub>j</sub> = 25 °C) - CONTINUED**

Color	Dominant Wavelength Range				Minimum Luminous Flux @ 350 mA		Calculated Minimum Luminous Flux (lm) @ 125 mA*	Order Code
	Min.		Max.		Group	Flux (lm)		
	Group	DWL (nm)	Group	DWL (nm)				
Amber	A2	585	A3	595	M2	39.8	14.9	XPCAMB-L1-0000-00201
					M3	45.7	17.1	XPCAMB-L1-0000-00301
					N2	51.7	19.4	XPCAMB-L1-0000-00401
					N3	56.8	21.3	XPCAMB-L1-0000-00501
					N4	62	23.3	XPCAMB-L1-0000-00601

Color	Dominant Wavelength Range				Minimum Luminous Flux @ 350 mA		Calculated Minimum Luminous Flux (lm) @ 125 mA*	Order Code
	Min.		Max.		Group	Flux (lm)		
	Group	DWL (nm)	Group	DWL (nm)				
Red-Orange	O3	610	O4	620	N2	51.7	19.8	XPCRDO-L1-0000-00401
					N3	56.8	21.7	XPCRDO-L1-0000-00501
					N4	62	23.7	XPCRDO-L1-0000-00601
					P2	67.2	25.7	XPCRDO-L1-0000-00701

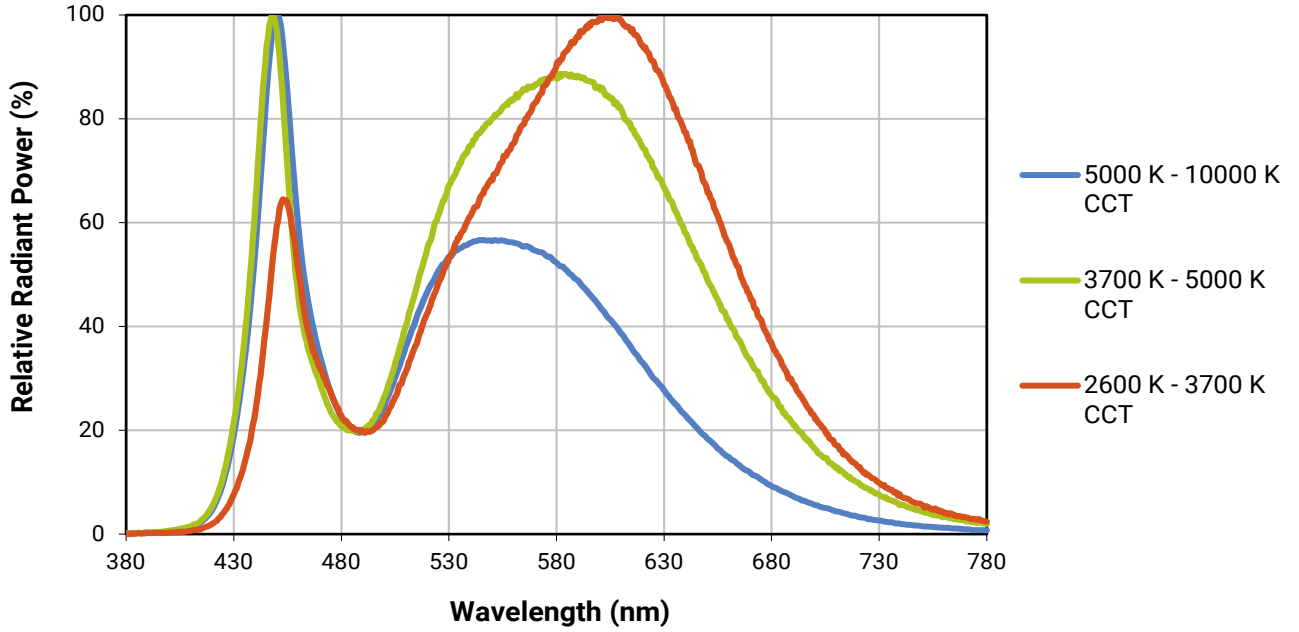
Color	Dominant Wavelength Range				Minimum Luminous Flux @ 350 mA		Calculated Minimum Luminous Flux (lm) @ 125 mA*	Order Code
	Min.		Max.		Group	Flux (lm)		
	Group	DWL (nm)	Group	DWL (nm)				
Red	R2	620	R3	630	M2	39.8	15.2	XPCRED-L1-0000-00201
					M3	45.7	17.5	XPCRED-L1-0000-00301
					N2	51.7	19.7	XPCRED-L1-0000-00401
					N3	56.8	21.7	XPCRED-L1-0000-00501

\* Calculated values for reference only

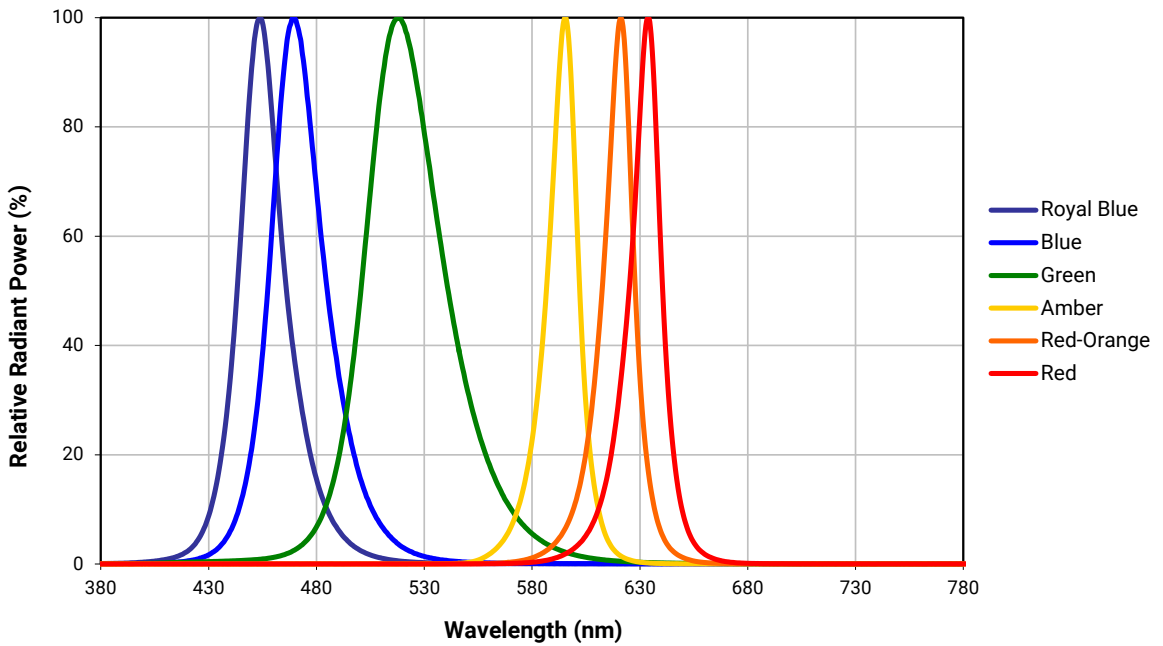
Note: Cree maintains a tolerance of ±7% on flux and power measurements and ±1 nm on dominant wavelength measurements. See the Measurements section (page 14).

**RELATIVE SPECTRAL POWER DISTRIBUTION**

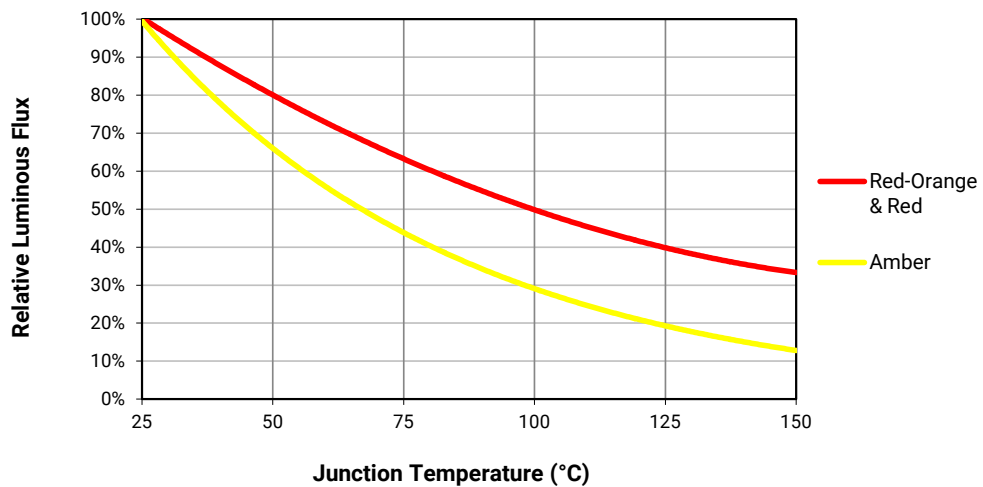
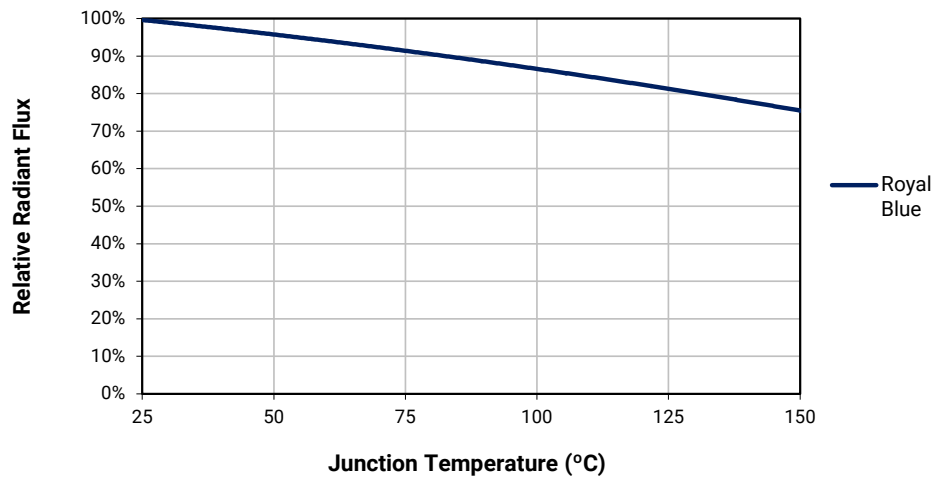
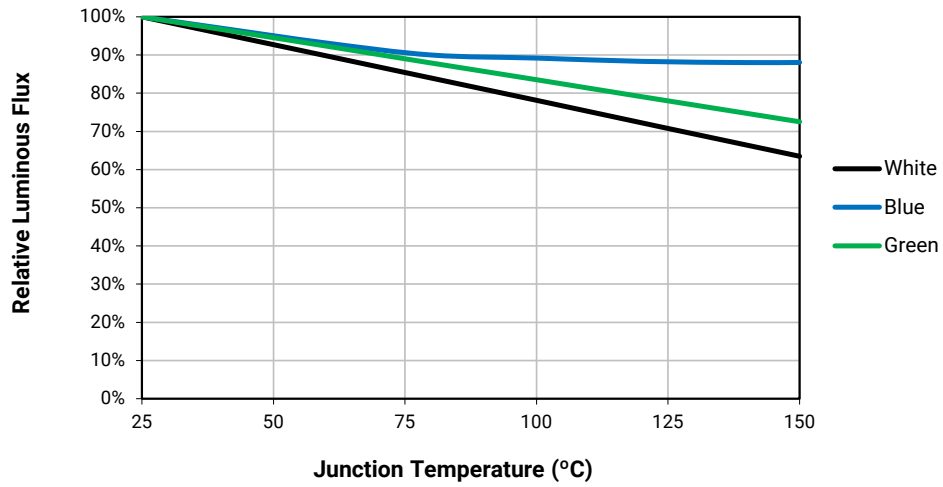
**White**



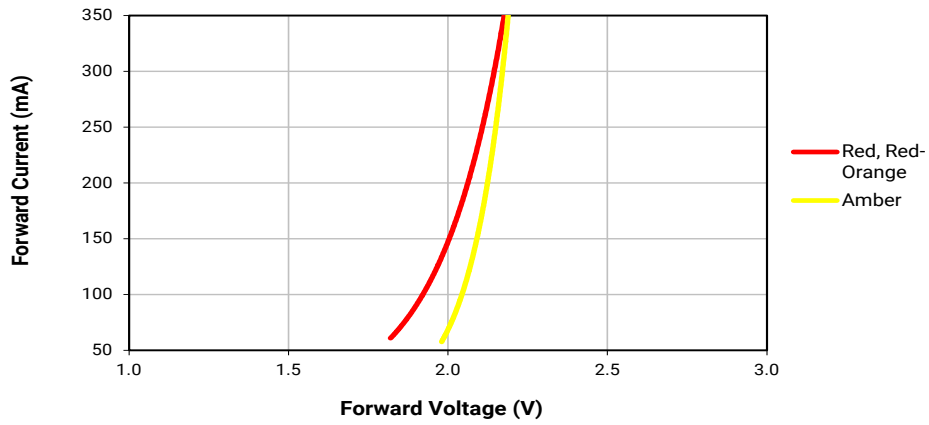
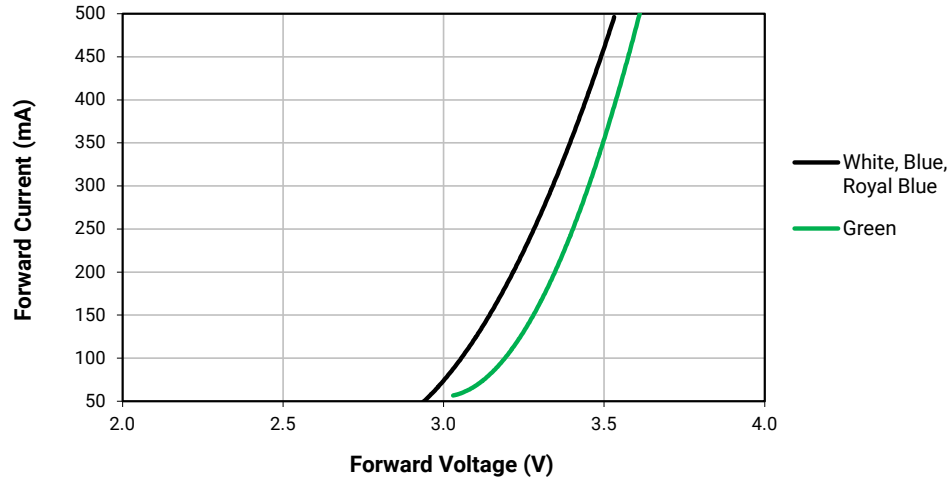
**Color**



**RELATIVE FLUX VS. JUNCTION TEMPERATURE ( $I_F = 350$  mA)**

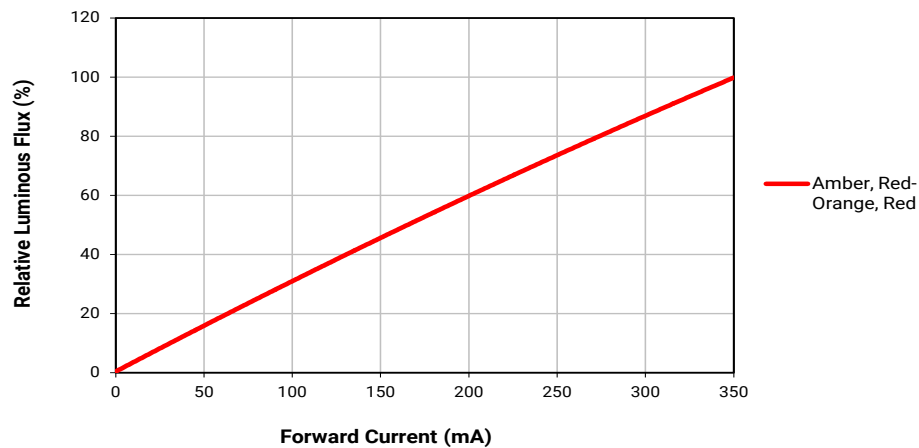
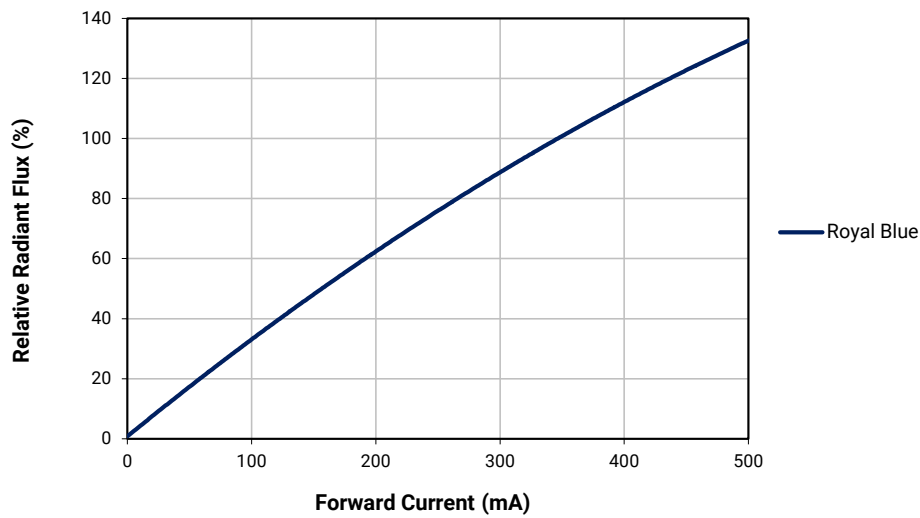
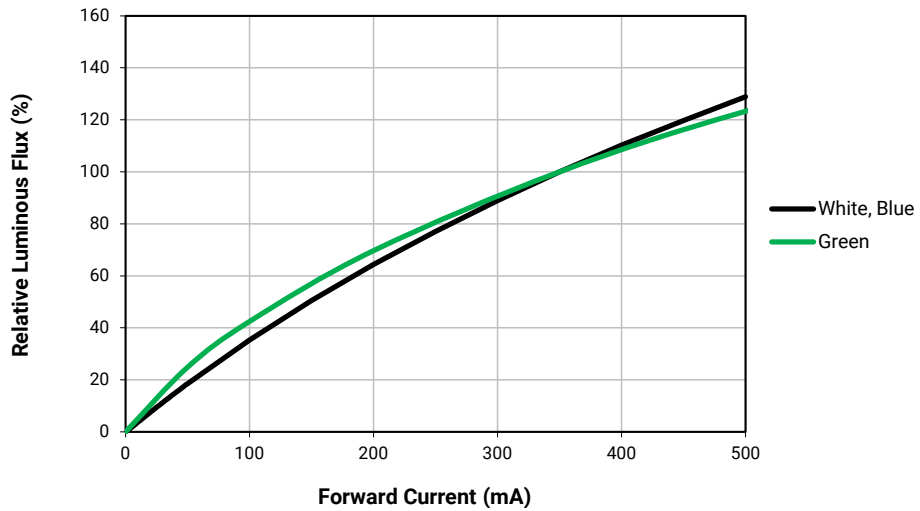


**ELECTRICAL CHARACTERISTICS ( $T_j = 25\text{ }^\circ\text{C}$ )**

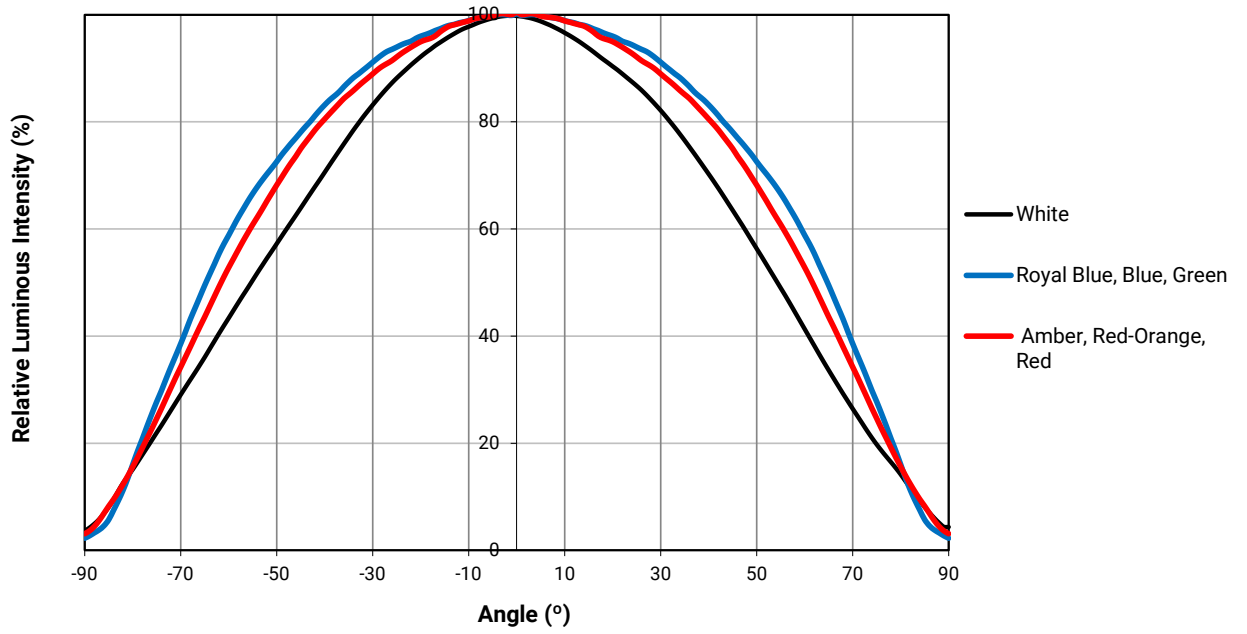




**RELATIVE FLUX VS. CURRENT ( $T_j = 25\text{ }^\circ\text{C}$ )**



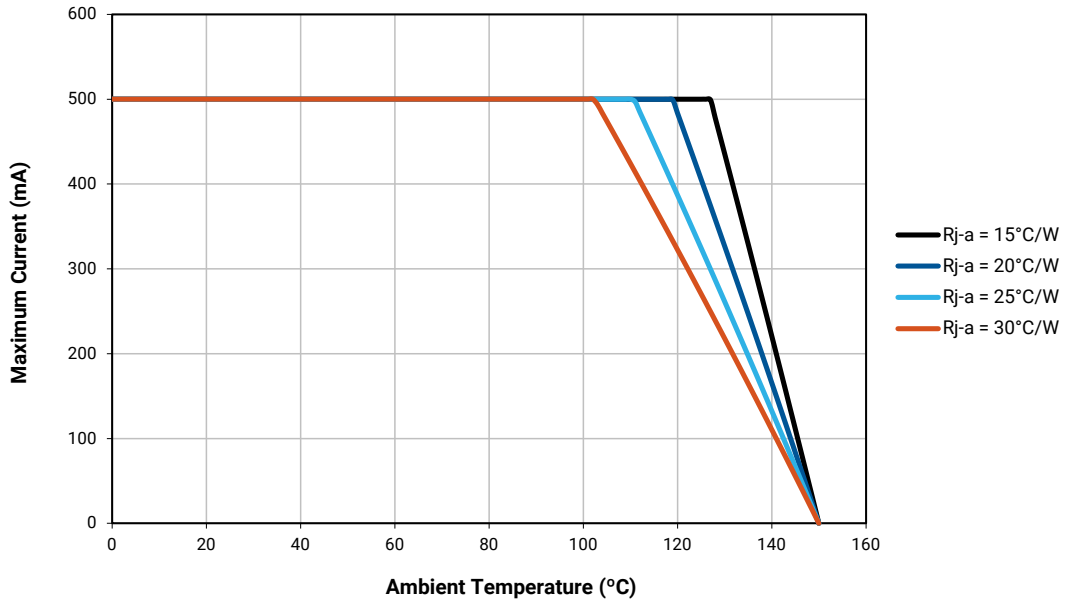
**TYPICAL SPATIAL DISTRIBUTION**



**THERMAL DESIGN**

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.

**White, Royal Blue, Blue**

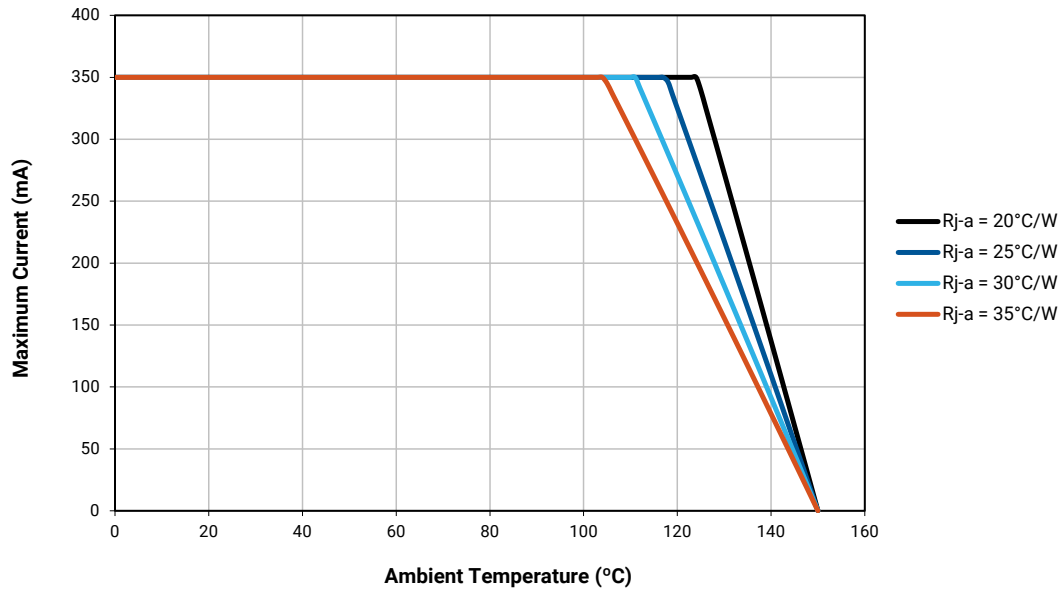


**Green**

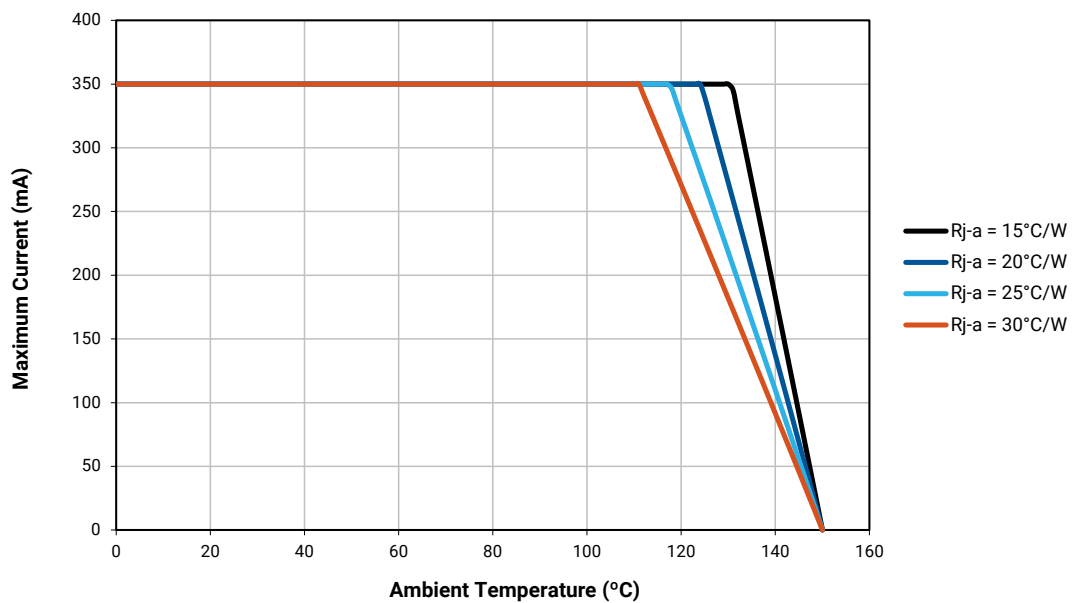


**THERMAL DESIGN - CONTINUED**

**Amber**



**Red-Orange, Red**



**REFLOW SOLDERING CHARACTERISTICS**

In testing, Cree has found XLamp XP-C LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of the solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



IPC/JEDEC J-STD-020C

Profile Feature	Lead-Free Solder
Average Ramp-Up Rate ( $T_{s_{max}}$ to $T_p$ )	1.2 °C/second
Preheat: Temperature Min ( $T_{s_{min}}$ )	120 °C
Preheat: Temperature Max ( $T_{s_{max}}$ )	170 °C
Preheat: Time ( $t_{s_{min}}$ to $t_{s_{max}}$ )	65-150 seconds
Time Maintained Above: Temperature ( $T_L$ )	217 °C
Time Maintained Above: Time ( $t_L$ )	45-90 seconds
Peak/Classification Temperature ( $T_p$ )	235 - 245 °C
Time Within 5 °C of Actual Peak Temperature ( $t_p$ )	20-40 seconds
Ramp-Down Rate	1 - 6 °C/second
Time 25 °C to Peak Temperature	4 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.

## NOTES

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### Measurements

The luminous flux, radiant power, chromaticity and CRI measurements in this document are binning specifications only and solely represent product measurements as of the date of shipment. These measurements will change over time based on a number of factors that are not within Cree's control and are not intended or provided as operational specifications for the products. Calculated values are provided for informational purposes only and are not intended as specifications.

### Pre-Release Qualification Testing

Please read the [LED Reliability Overview](#) for details of the qualification process Cree applies to ensure long-term reliability for XLamp LEDs and details of Cree's pre-release qualification testing for XLamp LEDs.

### Moisture Sensitivity

Cree recommends keeping XLamp LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain XLamp LEDs do not need special storage for moisture sensitivity.

Once the MBP is opened, XLamp XP-C LEDs may be stored as MSL 1 per JEDEC J-STD-033, meaning they have unlimited floor life in conditions of  $\leq 30$  °C/85% relative humidity (RH). Regardless of the storage condition, Cree recommends sealing any unsoldered LEDs in the original MBP.

### RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree representative or from the Product Documentation sections of [www.cree.com](http://www.cree.com).

### REACH Compliance

REACH substances of very high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACH SVHC Declaration. REACH banned substance information (REACH Article 67) is also available upon request.

### UL® Recognized Component

Level 4 enclosure consideration. The LED package or a portion thereof has been investigated as a fire and electrical enclosure per ANSI/UL 8750.

### Vision Advisory

WARNING: Do not look at an exposed lamp in operation. Eye injury can result. For more information about LEDs and eye safety, please refer to the [LED Eye Safety application note](#).

**NOTES - CONTINUED**

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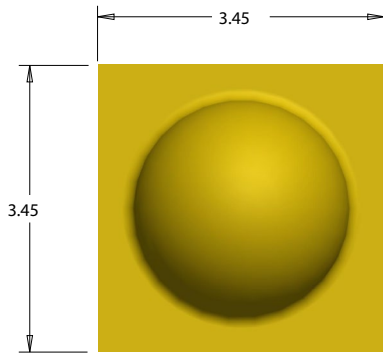
**Intellectual Property**

For remote phosphor applications, a separate license to certain Cree patents is required.

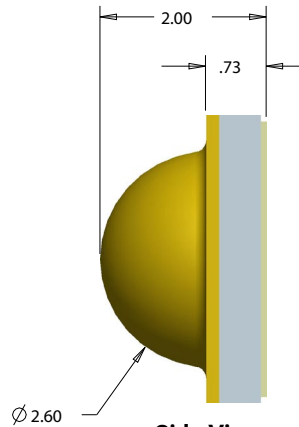
**MECHANICAL DIMENSIONS (T<sub>A</sub> = 25 °C)**

Thermal vias, if present, are not shown on these drawings.

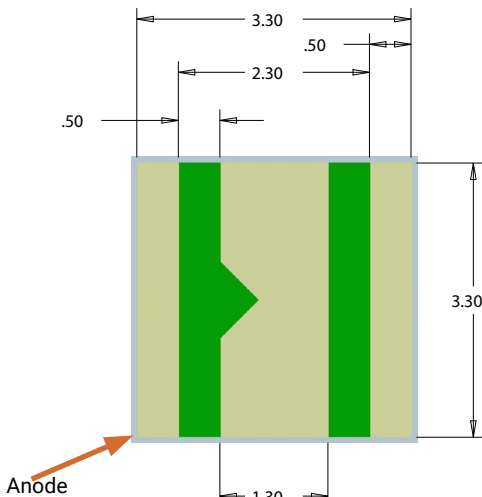
All measurements are ±.13 mm unless otherwise indicated.



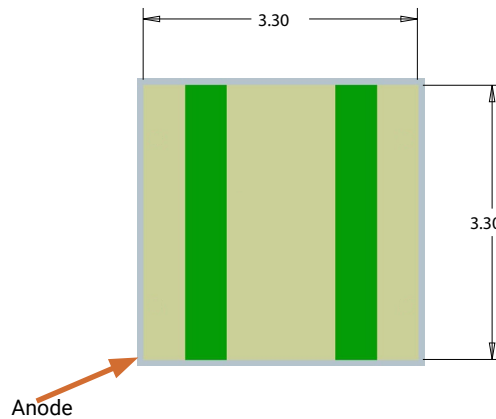
**Top View**



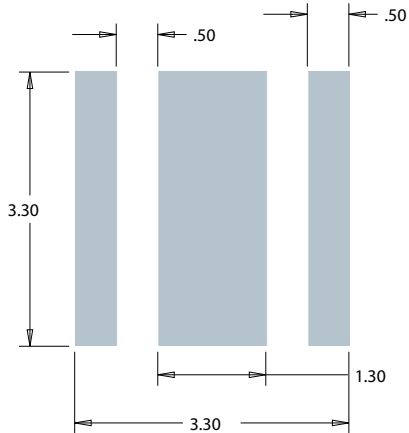
**Side View**



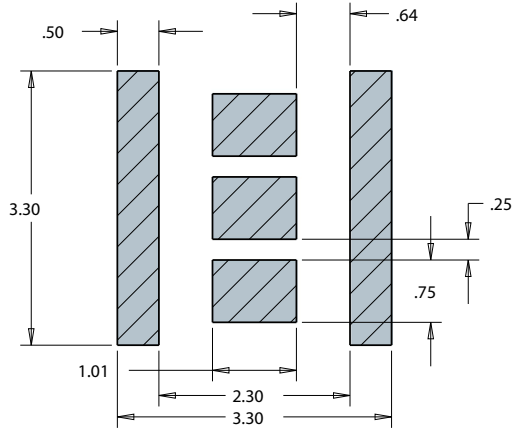
**Bottom View**



**Alternate Bottom View**



**Recommended PCB Solder Pad**



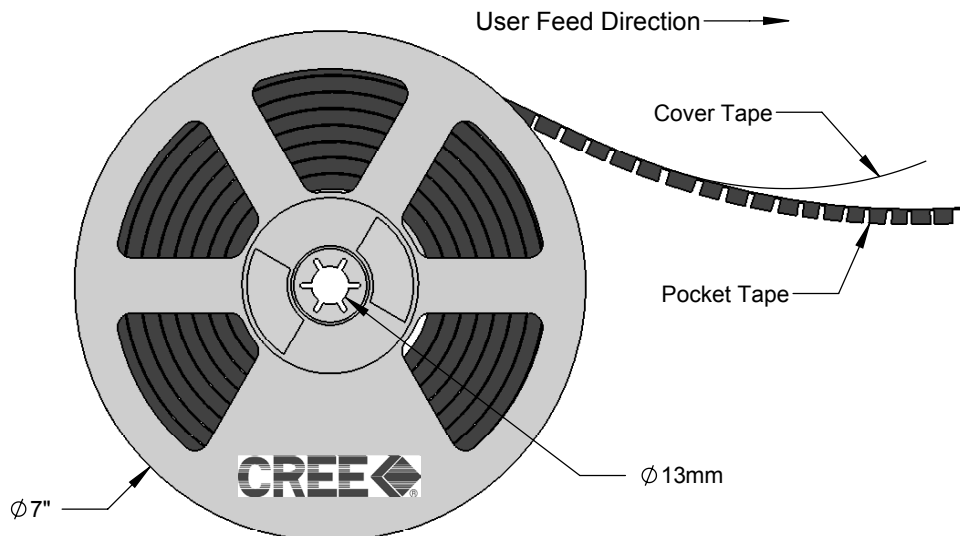
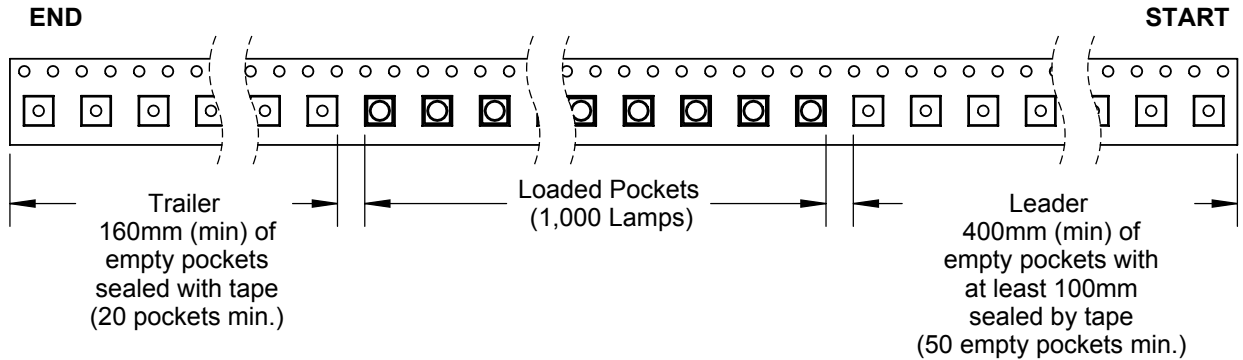
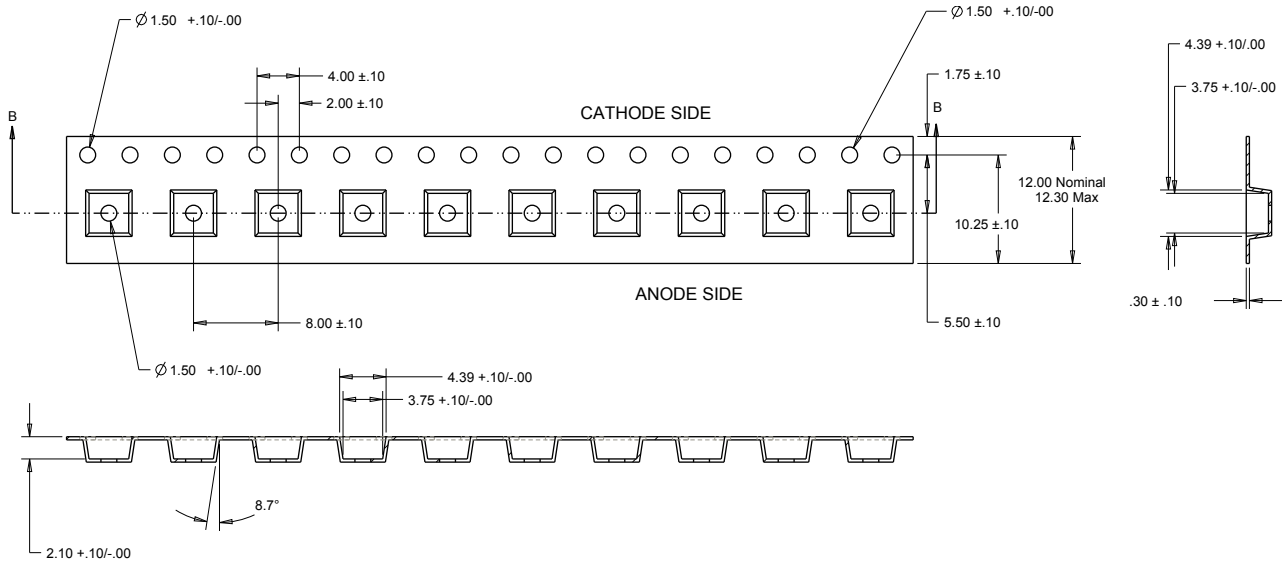
**Recommended Stencil Pattern  
(Hatched Area is Open)**



**TAPE AND REEL**

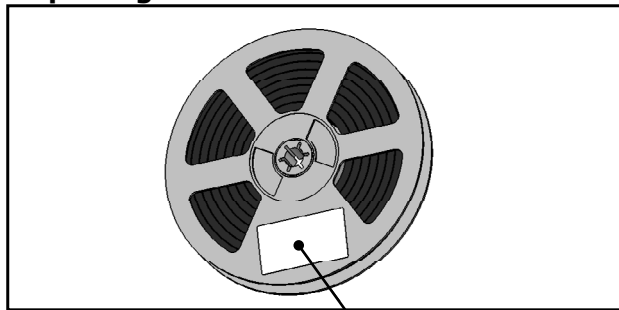
All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

Except as noted, all dimensions in mm.



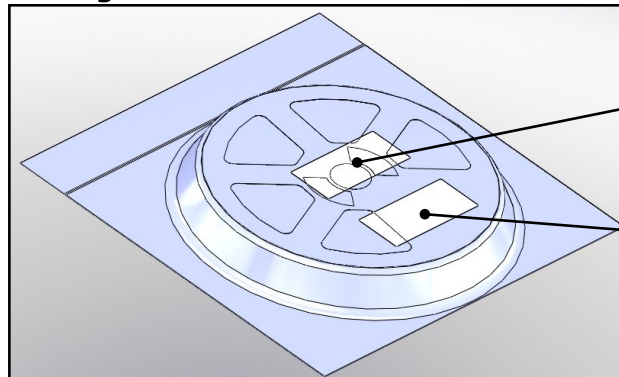
**PACKAGING**

**Unpackaged Reel**



Label with Cree Bin Code,  
Quantity, Reel ID

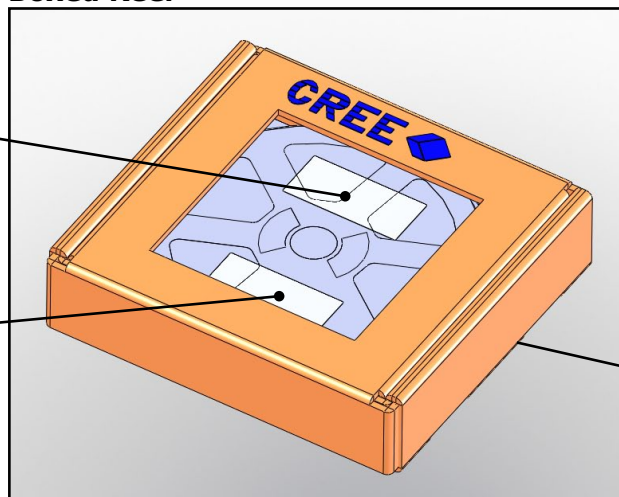
**Packaged Reel**



Label with Cree Order Code,  
Quantity, Reel ID, PO #

Label with Cree Bin Code,  
Quantity, Reel ID

**Boxed Reel**



Label with Cree Order Code,  
Quantity, Reel ID, PO #

Label with Cree Bin Code,  
Quantity, Reel ID

Patent Label  
(on bottom of box)